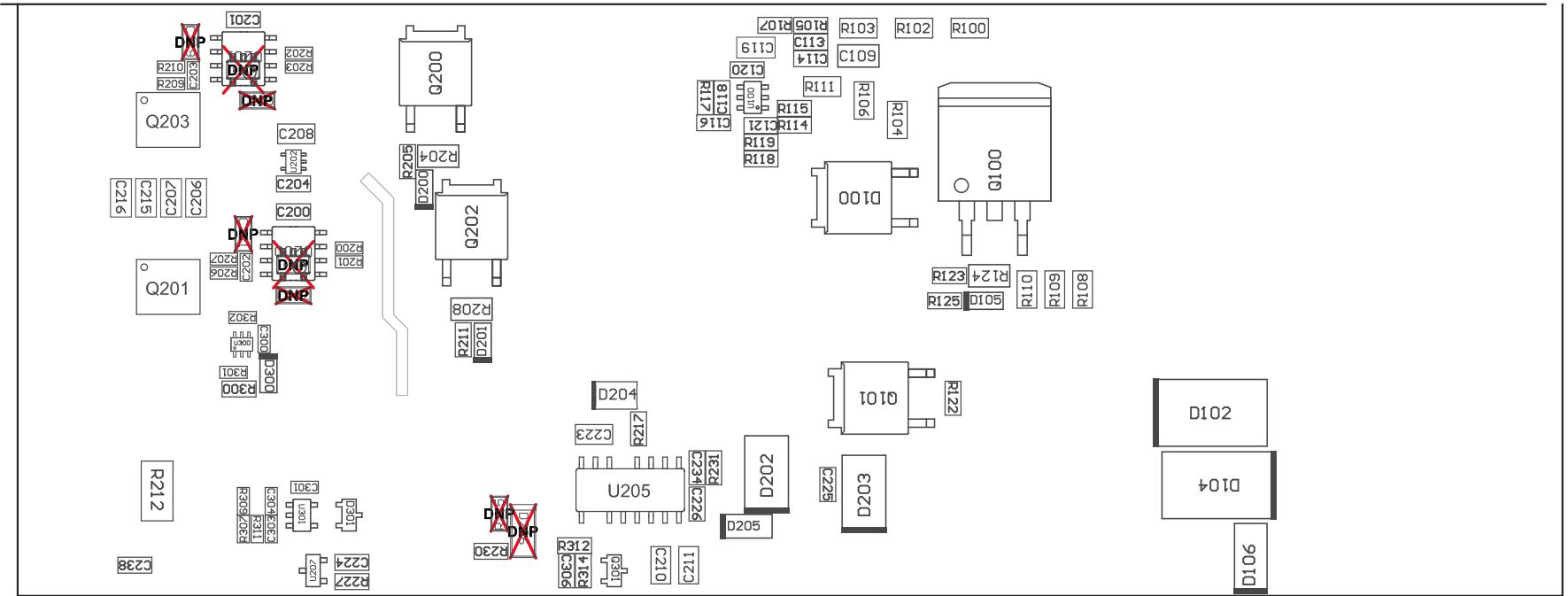


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM TOP SIDE | BOARD #: PMP21098 | REV: A | SUN REV: Not In VersionControl |
| | TID #: N/A | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 9/12/2017 5:22:08 PM | TEXAS INSTRUMENTS | |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

| | | | |
|-------------------------------------|----------------------------------|-------------------|--------------------------------|
| PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP21098 | REV: A | SUN REV: Not In VersionControl |
| | TID #: N/A | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 9/12/2017 5:22:11 PM | TEXAS INSTRUMENTS | |

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